



US00D686665S

(12) **United States Design Patent**
Bak et al.

(10) **Patent No.:** **US D686,665 S**
(45) **Date of Patent:** **** Jul. 23, 2013**

(54) **TRANSFER FILM**

(56) **References Cited**

(71) Applicant: **Samsung Electronics Co., Ltd.**,
Suwon-si (KR)
(72) Inventors: **Myeong-Hee Bak**, Seoul (KR); **Hea-Me Lee**, Seoul (KR)
(73) Assignee: **Samsung Electronics Co., Ltd.**,
Suwon-si, Gyeonggi-do (KR)
(**) Term: **14 Years**

U.S. PATENT DOCUMENTS			
236,244	A *	1/1881	Nurre 40/768
1,788,004	A *	1/1931	Williams 40/671
3,404,407	A *	10/1968	Lapidus 2/49.1
4,025,012	A *	5/1977	Chan et al. 248/163.1
4,216,598	A *	8/1980	Newbert 40/331
5,524,634	A *	6/1996	Turkel et al. 600/562
6,640,473	B1 *	11/2003	Shenk 40/124.11
D505,450	S *	5/2005	Lauer et al. D19/9
D635,194	S *	3/2011	Katz D20/27
D657,476	S *	4/2012	Mussini D25/163
2006/0143963	A1 *	7/2006	Nowakowski 40/673
2008/0098637	A1 *	5/2008	Pratt 40/673

(21) Appl. No.: **29/434,911**

OTHER PUBLICATIONS

(22) Filed: **Oct. 18, 2012**

U.S. Appl. No. 29/434,912, Applicant: Hea-Me Lee, et al., filed Oct. 18, 2012 entitled Transfer Film.

(30) **Foreign Application Priority Data**

* cited by examiner

May 10, 2012 (KR) 30-2012-0022844

(51) **LOC (9) Cl.** **19-08**

Primary Examiner — Mary Ann Calabrese

(52) **U.S. Cl.**

(74) *Attorney, Agent, or Firm* — Flynn, Thiel, Boutell & Tanis, P.C.

USPC **D20/11**

(58) **Field of Classification Search**

(57) **CLAIM**

USPC D20/10, 11, 22–28, 40, 99; 40/1.5,
40/6, 27.5, 124.01–124.09, 124.11–124.19,
40/124.191, 299.01, 300, 310, 312, 360,
40/630, 638, 673, 768; D5/8, 16, 43; D19/1,
D19/9–11; D99/34; 283/56, 71, 81, 88, 106,
283/107; 428/40.1, 42.1–42.3, 87, 195.1,
428/202, 914

The ornamental design for a transfer film, as shown and described.

DESCRIPTION

See application file for complete search history.

The FIGURE is a front surface view.
The transfer film of the present design has no substantial thickness.

1 Claim, 1 Drawing Sheet



